### Contents

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1	Electric	cal ratings	3
2	Electric	cal characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	rcuits	8
4	Packag	e information	9
	4.1	H <sup>2</sup> PAK-2 package information	10
	4.2	H <sup>2</sup> PAK-6 package information	13
	4.3	Packing information	16
5	Revisio	on history	



# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V <sub>DS</sub>	Drain-source voltage	100	V	
V <sub>GS</sub>	Gate-source voltage	± 20	V	
ا <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at $T_C = 25 \text{ °C}$	110	A	
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at $T_C = 100 \ ^{\circ}C$	76	А	
I <sub>D</sub> <sup>(2)</sup>	Drain current (continuous) at $T_{pcb} = 25 \text{ °C}$	18	A	
I <sub>D</sub> <sup>(2)</sup>	Drain current (continuous) at $T_{pcb}$ = 100 °C	13	А	
I <sub>DM</sub> <sup>(3)</sup>	Drain current (pulsed)	430	А	
P <sub>TOT</sub> <sup>(1)</sup>	Total dissipation at $T_C = 25 \ ^{\circ}C$	150	W	
E <sub>AS</sub> <sup>(4)</sup>	Single pulse avalanche energy	490	mJ	
TJ	Operating junction temperature	g junction temperature		
T <sub>stg</sub>	Storage temperature	-55 to 175 °C		

### Notes:

 $^{(1)}\mbox{This}$  value is rated according to  $R_{\mbox{thj-c}}$ 

 $^{(2)}$  This value is rated according to  $R_{thj\text{-pcb}}$ 

 $^{\rm (3)}{\rm Pulse}$  width limited by safe operating area

 $^{(4)}Starting T_J$  = 25 °C,  $I_D$  = 18,  $V_{DD}$  = 50 V

### **Table 3: Thermal resistance**

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	1	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	35	°C/W

### Notes:

 $^{(1)}\!When$  mounted on FR-4 board of 1 inch², 2 oz Cu



# 2 Electrical characteristics

 $(T_{CASE} = 25 \text{ °C unless otherwise specified})$ 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage (V <sub>GS</sub> = 0)	I <sub>D</sub> = 250 μA	100			V
		V <sub>DS</sub> = 100 V			1	μA
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 100 V; T <sub>C</sub> = 125 °C			100	μA
I <sub>GSS</sub>	Gate body leakage current $(V_{DS} = 0)$	V <sub>GS</sub> = 20 V			100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5		4.5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 55 A		4.9	6.5	mΩ

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance			5117		pF
C <sub>oss</sub>	Output capacitance	$V_{\text{DS}} = 50 \text{ V}, \text{ f} = 1 \text{ MHz},$		992		pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0$	-	39	-	pF
Qg	Total gate charge	$V_{DD} = 50 \text{ V}, I_D = 110 \text{ A}$		72		nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V		31		nC
Q <sub>gd</sub>	Gate-drain charge	See Figure 14: "Gate charge test circuit"		16		nC

### Table 5: Dynamic

### Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 55 \text{ A},$		25		ns
tr	Rise time	$R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 10 V		36		ns
t <sub>d(off)</sub>	Turn-off delay time	See Figure 13: "Switching times test	-	52	-	ns
t <sub>f</sub>	Fall time	circuit for resistive load"		21		ns



### Electrical characteristics

	Table 7: Source-drain diode					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current				110	А
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				430	А
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 55 \text{ A}, V_{GS} = 0$			1.2	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 110 A,	-	77		ns
Qrr	Reverse recovery charge	di/dt = 100 A/µs,		150		nC
I <sub>RRM</sub>	Reverse recovery current	V <sub>DD</sub> = 80 V, T <sub>j</sub> = 150 °C		4.3		А

### Notes:

<sup>(1)</sup>Pulse width limited by safe operating area

 $^{(2)}$ Pulsed: pulse duration = 300  $\mu s,$  duty cycle 1.5%



1

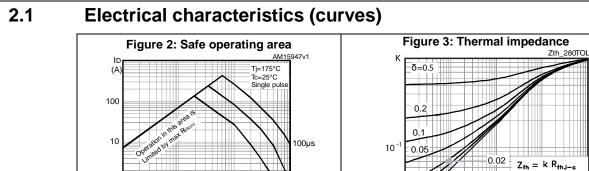
0.1

 $\delta={\rm t_p}/\tau$ 

t,

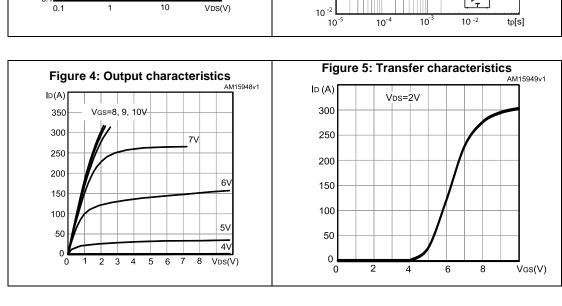
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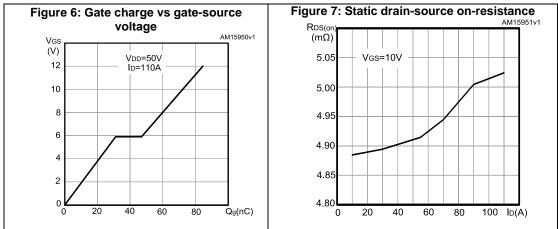
Single pulse



1ms

10ms

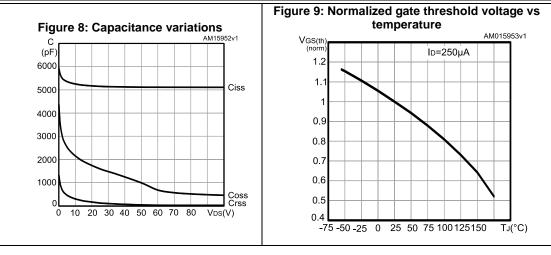


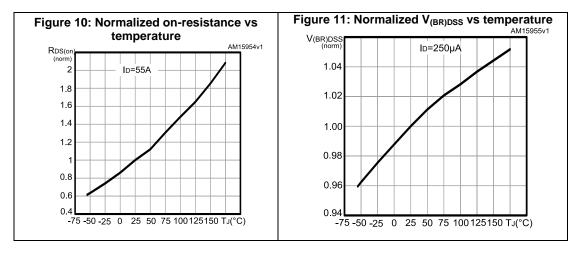


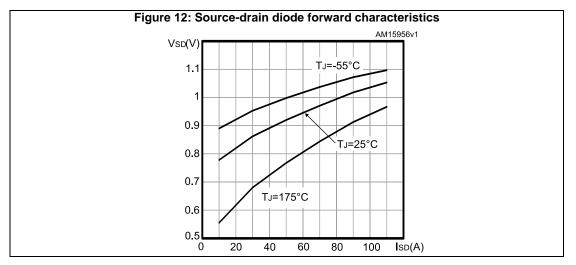
6/19



#### **Electrical characteristics**

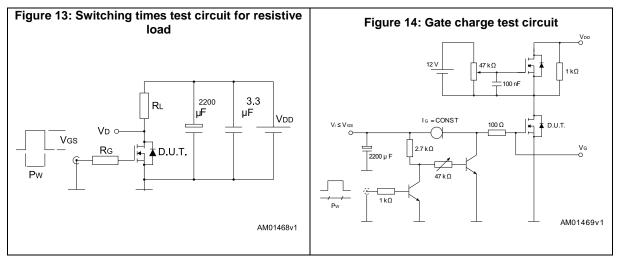


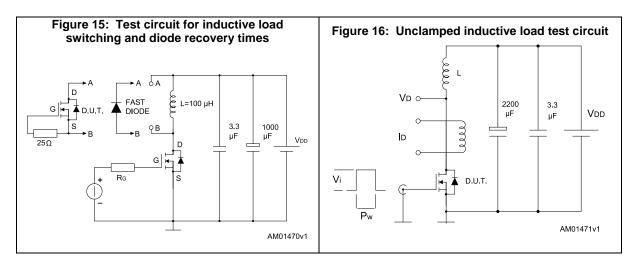


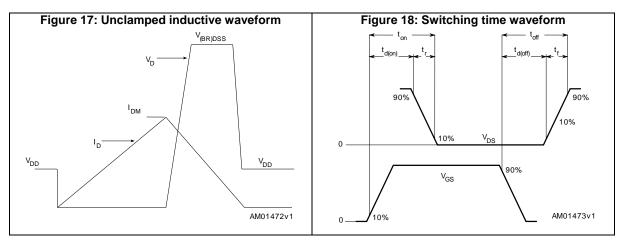


57

### 3 Test circuits







DocID024027 Rev 4

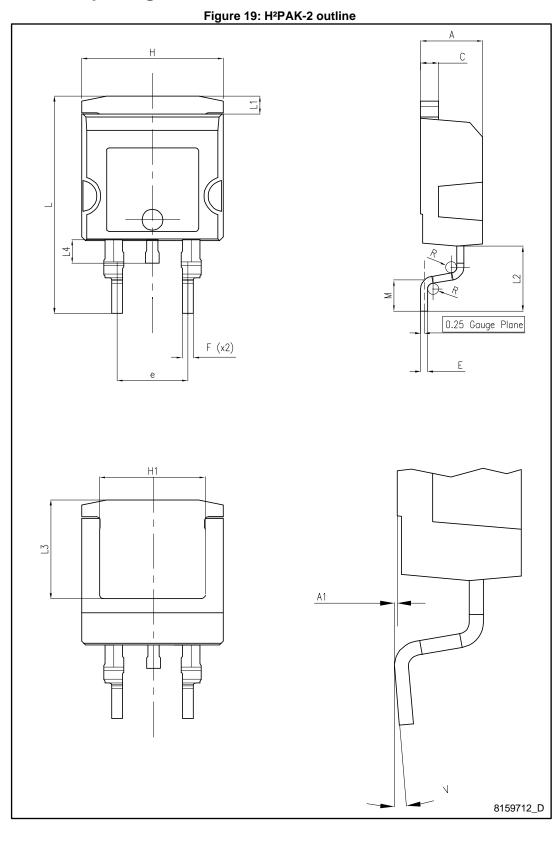
57

### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



# 4.1 H<sup>2</sup>PAK-2 package information



10/19



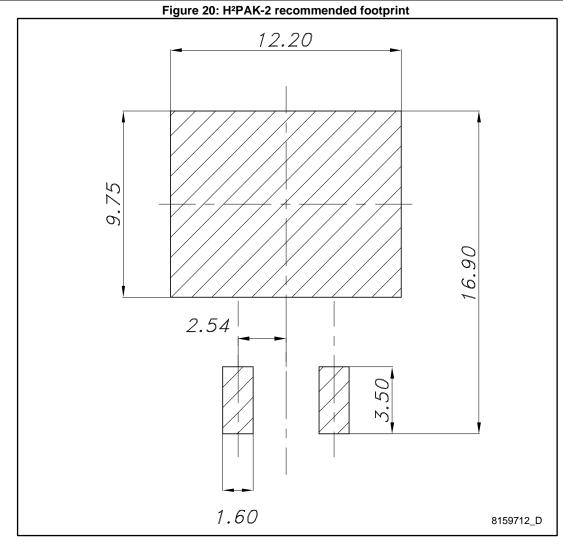
### Package information

UF7-2, STH110N10F7-6 Package Information						
	Table 8: H <sup>2</sup> PAK-2	mechanical data				
Dim		mm				
Dim.	Min.	Тур.	Max.			
A	4.30		4.80			
A1	0.03		0.20			
С	1.17		1.37			
е	4.98		5.18			
E	0.50		0.90			
F	0.78		0.85			
Н	10.00		10.40			
H1	7.40		7.80			
L	15.30	-	15.80			
L1	1.27		1.40			
L2	4.93		5.23			
L3	6.85		7.25			
L4	1.5		1.7			
М	2.6		2.9			
R	0.20		0.60			
V	0°		8°			



Package information

STH110N10F7-2, STH110N10F7-6





# 4.2 H<sup>2</sup>PAK-6 package information

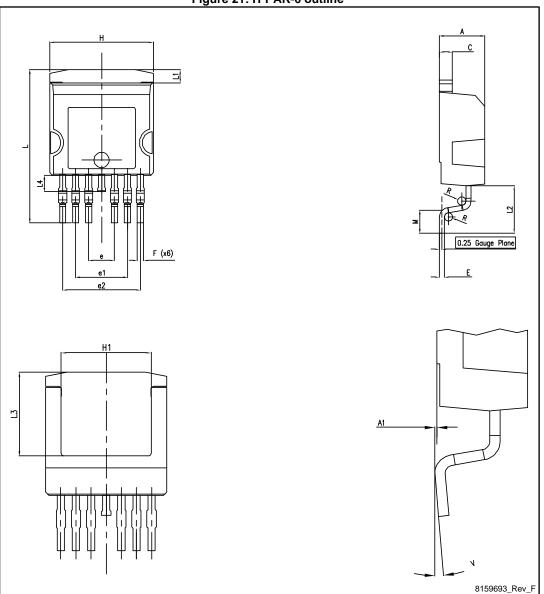


Figure 21: H<sup>2</sup>PAK-6 outline



### Package information

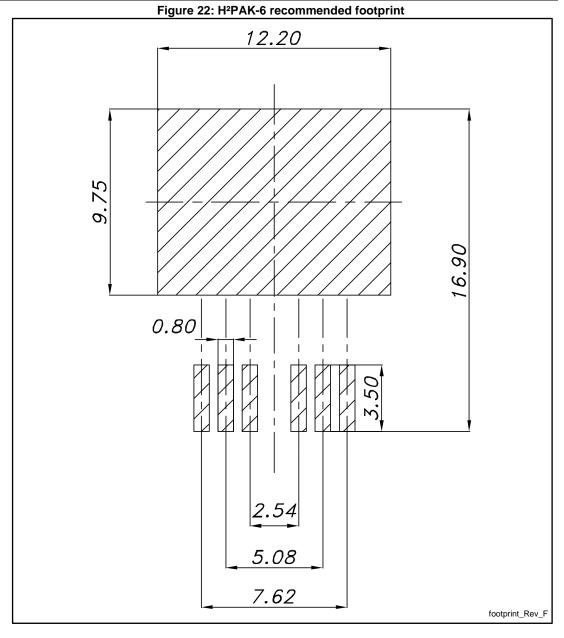
### STH110N10F7-2, STH110N10F7-6

nformation		STH110N10	)F7-2, STH110N10F7-6		
	Table 9: H <sup>2</sup> PAK-6	mechanical data			
Dim	mm				
Dim.	Min.	Тур.	Max.		
A	4.30		4.80		
A1	0.03		0.20		
С	1.17		1.37		
е	2.34		2.74		
e1	4.88		5.28		
e2	7.42		7.82		
E	0.45		0.60		
F	0.50		0.70		
Н	10.00		10.40		
H1	7.40	-	7.80		
L	14.75		15.25		
L1	1.27		1.40		
L2	4.35		4.95		
L3	6.85		7.25		
L4	1.5		1.75		
М	1.90		2.50		
R	0.20		0.60		
V	0°		8°		

14/19 DocID024027 Rev 4



### Package information





Dimensions are in mm.



### 4.3 Packing information

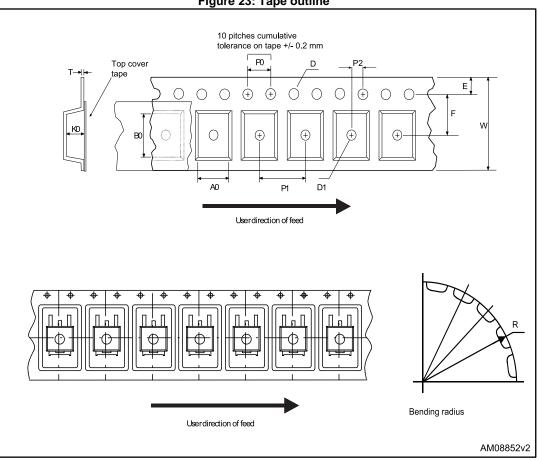
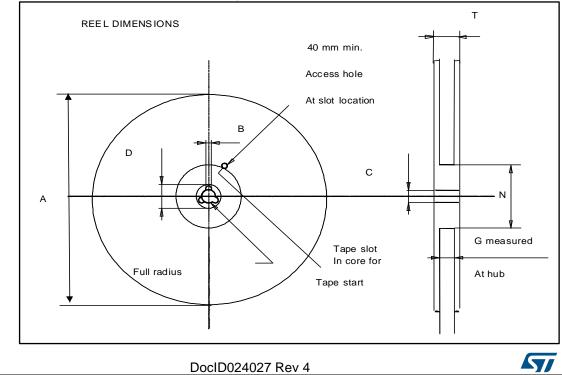


Figure 23: Tape outline





16/19

0F7-2, STH110	F7-2, STH110N10F7-6 Package information					
	Та	ble 10: Tape and	reel mechanical	data		
	Таре			Reel		
Dim	n	nm	Dim	m	ım	
Dim.	Min.	Max.	Dim.	Min.	Max.	
A0	10.5	10.7	А		330	
B0	15.7	15.9	В	1.5		
D	1.5	1.6	С	12.8	13.2	
D1	1.59	1.61	D	20.2		
E	1.65	1.85	G	24.4	26.4	
F	11.4	11.6	N	100		
K0	4.8	5.0	Т		30.4	
P0	3.9	4.1				
P1	11.9	12.1	Base o	quantity	1000	
P2	1.9	2.1	Bulk q	uantity	1000	
R	50					
Т	0.25	0.35				
W	23.7	24.3				



# 5 Revision history

Table 11: Document revision history

\_\_\_\_\_

Date	Revision	Changes	
10-Dec-2012	1	Initial release. Part number (STH110N10F7-2) previously included in datasheet ID024005	
16-Jul-2013	2	<ul> <li>Modified: title</li> <li>Modified: I<sub>DM</sub> value in <i>Table 2: "Absolute maximum ratings"</i>, the entire typical values in <i>Table 5: "Dynamic"</i>, <i>Table 6: "Switching times"</i> and <i>Table 7: "Source-drain diode"</i></li> <li>Minor text changes</li> </ul>	
11-Nov-2014	3	<ul> <li>Updated: H<sup>2</sup>PAK-6 package information.</li> <li>Updated the title, features and description.</li> <li>Minor text changes.</li> </ul>	
26-Nov-2014	4	Changed from <i>Figure 2:</i> "Safe operating area" to <i>Figure 12:</i> "Source-drain diode forward characteristics".	



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